



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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SMT inductors

Transponder coils, size 1210 (EIA)

Series/Type:	TC 1210
Ordering code:	B82450A*C000
Date:	2015-11-02
Version:	03

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Size 1210 (EIA) or 3225 (IEC)



Construction

- Ferrite drum core
- Laser-welded winding with non-solderable wire
- Flame-retardant molding

Features

- Temperature range up to +125 °C
- High Sensitivity in X/Y orientation
- High Quality factor
- Qualified to AEC-Q200
- Suitable for lead-free reflow soldering as referenced in JEDEC J-STD 020D
- RoHS-compatible

Applications

- Transponder coil in TPMS (Tire Pressure Monitoring System)

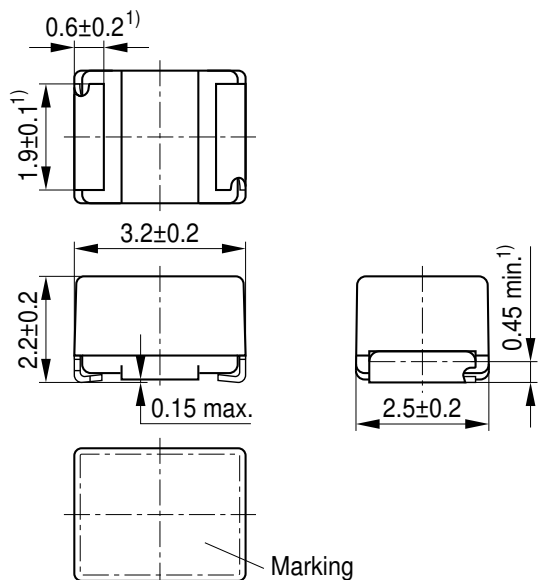
Terminals

- Base material CuSn6
- Layer composition Cu, Ag, Sn (lead-free)
- Electro-plated

Delivery mode and packing units

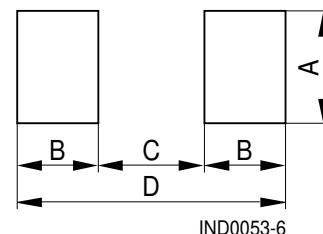
- 8-mm blister tape, wound on 180-mm or 330-mm Ø reel
- Packing units:
 - 180-mm reel: 2000 pcs./reel
 - 330-mm reel: 7500 pcs./reel

Dimensional drawing and layout recommendation



1) Soldering area

IND0496-P-E



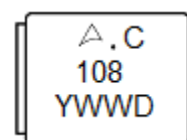
IND0053-6

A	B	C	D
2.7	1.15	2.1	4.4

Dimensions in mm

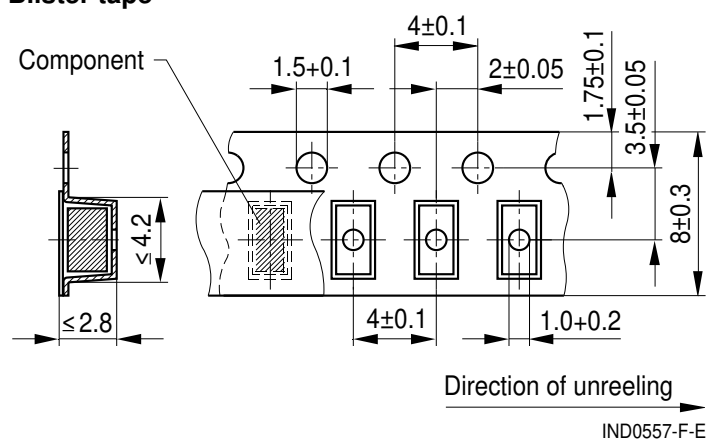
Marking on component

- .C – 1210 Transponder coil (B82450A*C*)
- 108 – Inductance value without exponent (B82450A1084C*)
- YWWD – Date code



Taping and packing

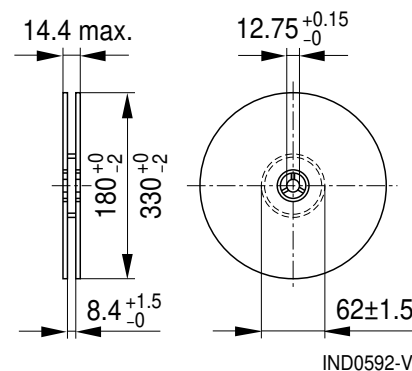
Blister tape



Dimensions in mm

IND0557-F-E

Reel



IND0592-V

Technical data and measuring conditions

Rated inductance L_R	Measured with impedance analyzer Agilent 4294A at frequency f_L , 0.5 V, +20 °C
Q factor Q_{min}	Measured with impedance analyzer Agilent 4294A at frequency f_Q , +20 °C
Rated temperature T_R	+125 °C
Self-resonance frequency $f_{res,min}$	Measured with impedance analyzer Agilent 8753D at +20 °C
DC resistance R_{max}	Measured at +20 °C
Solderability (lead-free)	Sn95.5Ag3.8Cu0.7: +(245 ± 5) °C, (5 ± 3) s wetting of soldering area ≥ 90% (based on IEC 60068-2-58)
Resistance to soldering heat	+260 °C, 40 s (as referenced in JEDEC J-STD 020D)
Climatic category	40/125/56 (to IEC 60068-1)
Storage conditions	Mounted: -40 °C...+125 °C Packaged: -25 °C...+40 °C, ≤ 75% RH
Weight	Approx. 50 mg

Characteristics and ordering codes

L_R	L	f_L, f_Q	Q_{min}	S_{typ}	R_{max}	F_{res}	Ordering code
μH	tolerance	kHz		$\frac{mV}{\mu T}$	Ω	MHz	
1080	±5%	125	15	3.4	35	>2.5	B82450A1084C00*
1340	±5%	125	15	3.7	42	>2.0	B82450A1344C00*

Composition of ordering code

* = reel size
 0 = Ø 180 mm
 8 = Ø 330 mm

Cautions and warnings

- Please note the recommendations in our data book (latest edition) and in the data sheets.
 - Particular attention should be paid to the derating curves given there.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing

- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or glued on joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.

Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.

- The following points must be observed if the components are potted in customer applications:
 - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
 - The effect of the potting material can change the high-frequency behaviour of the components.

- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.

- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

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